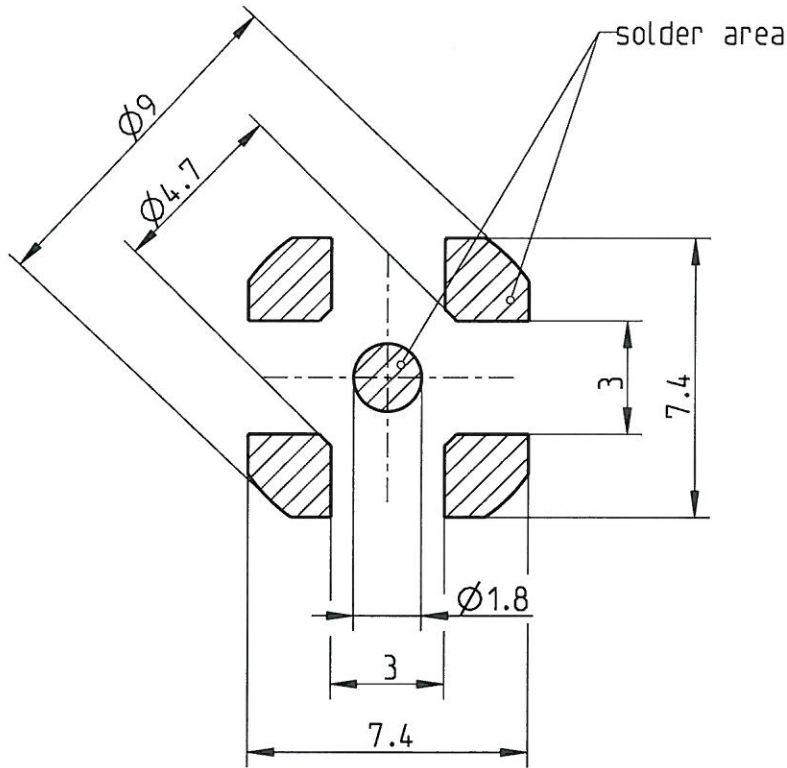


All rights strictly reserved. Reproduction or issue to third parties in any form whatsoever is not permitted without written authority from the proprietor. Property of Rosenberger Hochfrequenztechnik.

Leiterplatten-Layout  
PCB layout  
B 163



fuer diese technische Unterlage behalten wir uns alle Rechte vor (DIN 34)

A wide variety of transmissionline topologies and pcb-parameters like permittivity, substrate thickness, and board-stackup are applied by customers. These parameters have a strong impact on the high frequency performance of the mounted connector.

Please note, that the given layout is not optimised to fit all of the possible board configurations regarding RF-performance, it represents a recommendation for optimum solderability of the connector. In order to guarantee optimum high frequency properties of the connector, an RF-analysis of the connector to board transition is recommended.

Formblatt: TC\_CFB\_05\_PZ\_AK\_Einstellfkt  
Pfad: I:\Pz-Config\Bauelemente\Datei: A\_Krautenbac\LEB\_RH\_Vers:03\_13

ISO-Projektion Methode E -METRIC-

<b>Rosenberger</b> Hochfrequenztechnik 84526 Tittmoning Pro/ENGINEER				general tolerance <b>ISO 2768 m-H</b>		<b>RN 006-01</b> dimensions <0,5 and symmetry		scale: 5:1	weight(g): surface(mm <sup>2</sup> ):
				date drawn 27.11.2002 check 10.5.06 appr. 10.05.06		name A_Nobis <i>WZ</i> <i>Krautenbac</i>		title: <b>Leiterplatten-Layout PCB layout</b>	
				dimensioning incl. finish		drawing-no.: <b>MB_163</b>		sheet: 1	
b00 06-0194 S_Krautenbac 03.05.2006 a00 02-s396 A_Nobis 27.11.2002				distribution to:		FE AZ QSM RMT . X . . . .		of: 1	
rev. change-no name date								remarks: .	